

# 74AUP1Z125

Low-power X-tal driver with enable and internal resistor;  
3-state

Rev. 5 — 8 August 2012

Product data sheet

## 1. General description

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The 74AUP1Z125 combines the functions of the 74AUP1GU04 and 74AUP1G125 with enable circuitry and an internal bias resistor to provide a device optimized for use in crystal oscillator applications.

When not in use the  $\overline{\text{EN}}$  input can be driven HIGH, pulling up the X1 input and putting the device in a low-power disable mode. Schmitt trigger action at the  $\overline{\text{EN}}$  input makes the circuit tolerant to slower input rise and fall times across the entire  $V_{\text{CC}}$  range from 0.8 V to 3.6 V.

This device is fully specified for partial power-down applications using  $I_{\text{OFF}}$  at output Y. The  $I_{\text{OFF}}$  circuitry disables the output Y, preventing the damaging backflow current through the device when it is powered down.

The integration of the two devices into the 74AUP1Z125 produces the benefits of a compact footprint, lower power dissipation and stable operation over a wide range of frequency and temperature.

## 2. Features and benefits

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- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- ESD protection:
  - ◆ HBM JESD22-A114F Class 3A exceeds 5000 V
  - ◆ MM JESD22-A115-A exceeds 200 V
  - ◆ CDM JESD22-C101E exceeds 1000 V
- Latch-up performance exceeds 100 mA per JESD78B Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of  $V_{\text{CC}}$
- $I_{\text{OFF}}$  circuitry provides partial power-down mode operation at output Y
- Multiple package options
- Specified from  $-40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$  and  $-40\text{ }^{\circ}\text{C}$  to  $+125\text{ }^{\circ}\text{C}$



### 3. Ordering information

Table 1. Ordering information

Type number	Package			Version
	Temperature range	Name	Description	
74AUP1Z125GW	-40 °C to +125 °C	SC-88	plastic surface-mounted package; 6 leads	SOT363
74AUP1Z125GM	-40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1.45 × 0.5 mm	SOT886
74AUP1Z125GF	-40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 × 1 × 0.5 mm	SOT891
74AUP1Z125GN	-40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 0.9 × 1.0 × 0.35 mm	SOT1115
74AUP1Z125GS	-40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 1.0 × 1.0 × 0.35 mm	SOT1202

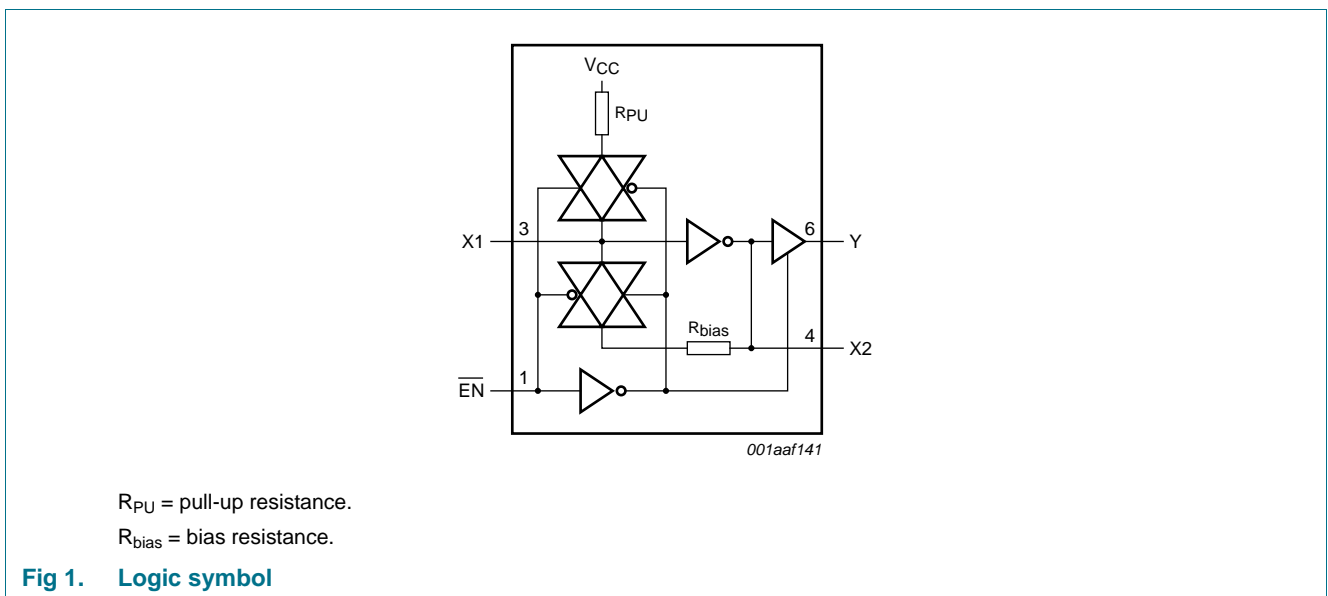
### 4. Marking

Table 2. Marking

Type number	Marking code <sup>[1]</sup>
74AUP1Z125GW	55
74AUP1Z125GM	55
74AUP1Z125GF	55
74AUP1Z125GN	55
74AUP1Z125GS	55

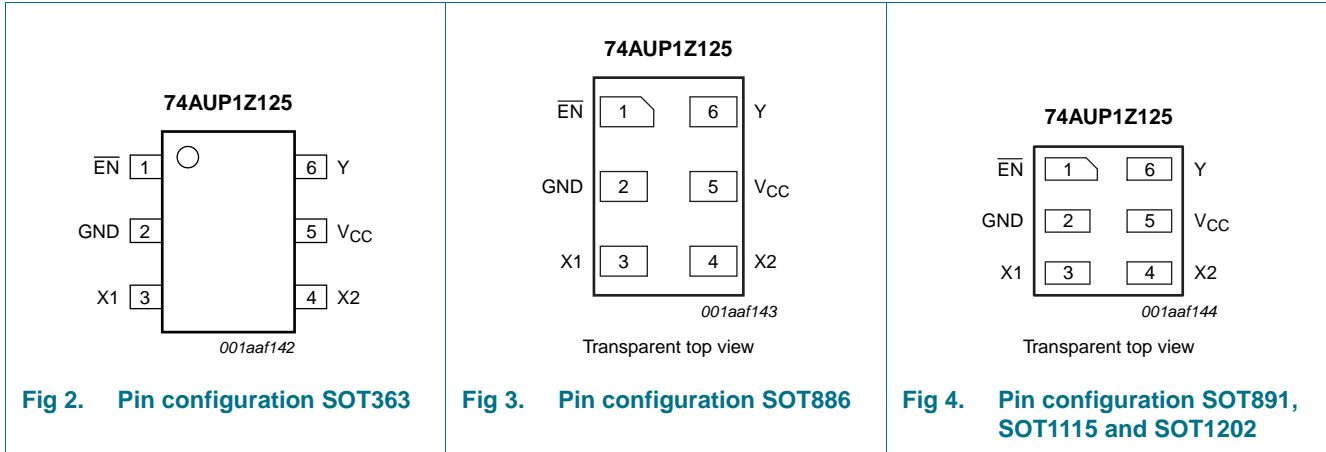
[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

### 5. Functional diagram



## 6. Pinning information

### 6.1 Pinning



### 6.2 Pin description

Table 3. Pin description

Symbol	Pin	Description
$\overline{\text{EN}}$	1	enable input (active LOW)
GND	2	ground (0 V)
X1	3	data input
X2	4	unbuffered output
V <sub>CC</sub>	5	supply voltage
Y	6	data output

## 7. Functional description

Table 4. Function table<sup>[1]</sup>

Input		Output		
$\overline{\text{EN}}$	X1	X2	Y	
L	L	H	H	
L	H	L	L	
H	L	H	Z	
H	H	L	Z	

[1] H = HIGH voltage level;  
 L = LOW voltage level;  
 Z = high-impedance OFF-state.

## 8. Limiting values

**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+4.6	V
$I_{IK}$	input clamping current	$V_I < 0$ V	-50	-	mA
$V_I$	input voltage		[1] -0.5	+4.6	V
$I_{OK}$	output clamping current	$V_O < 0$ V	-50	-	mA
$V_O$	output voltage	Active mode and Power-down mode	[1] -0.5	+4.6	V
$I_O$	output current	$V_O = 0$ V to $V_{CC}$	-	$\pm 20$	mA
$I_{CC}$	supply current		-	50	mA
$I_{GND}$	ground current		-50	-	mA
$T_{stg}$	storage temperature		-65	+150	°C
$P_{tot}$	total power dissipation	$T_{amb} = -40$ °C to +125 °C	[2] -	250	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SC-88 packages: above 87.5 °C the value of  $P_{tot}$  derates linearly with 4.0 mW/K.  
For XSON6 packages: above 118 °C the value of  $P_{tot}$  derates linearly with 7.8 mW/K.

## 9. Recommended operating conditions

**Table 6. Recommended operating conditions**

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		0.8	3.6	V
$V_I$	input voltage		0	3.6	V
$V_O$	output voltage		0	$V_{CC}$	V
$T_{amb}$	ambient temperature		-40	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 0.8$ V to 3.6 V	-	200	ns/V

## 10. Static characteristics

**Table 7. Static characteristics**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>T<sub>amb</sub> = 25 °C</b>						
V <sub>IH</sub>	HIGH-level input voltage	X1 input				
		V <sub>CC</sub> = 0.8 V to 3.6 V	0.75 × V <sub>CC</sub>	-	-	V
		$\overline{\text{EN}}$ input				
		V <sub>CC</sub> = 0.8 V	0.70 × V <sub>CC</sub>	-	-	V
		V <sub>CC</sub> = 0.9 V to 1.95 V	0.65 × V <sub>CC</sub>	-	-	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.6	-	-	V
		V <sub>CC</sub> = 3.0 V to 3.6 V	2.0	-	-	V
V <sub>IL</sub>	LOW-level input voltage	X1 input				
		V <sub>CC</sub> = 0.8 V to 3.6 V	-	-	0.25 × V <sub>CC</sub>	V
		$\overline{\text{EN}}$ input				
		V <sub>CC</sub> = 0.8 V	-	-	0.30 × V <sub>CC</sub>	V
		V <sub>CC</sub> = 0.9 V to 1.95 V	-	-	0.35 × V <sub>CC</sub>	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	V
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	-	0.9	V
V <sub>OH</sub>	HIGH-level output voltage	Y output; V <sub>I</sub> at X1 input = V <sub>IH</sub> or V <sub>IL</sub>				
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 0.8 V to 3.6 V	V <sub>CC</sub> - 0.1	-	-	V
		I <sub>O</sub> = -1.1 mA; V <sub>CC</sub> = 1.1 V	0.75 × V <sub>CC</sub>	-	-	V
		I <sub>O</sub> = -1.7 mA; V <sub>CC</sub> = 1.4 V	1.11	-	-	V
		I <sub>O</sub> = -1.9 mA; V <sub>CC</sub> = 1.65 V	1.32	-	-	V
		I <sub>O</sub> = -2.3 mA; V <sub>CC</sub> = 2.3 V	2.05	-	-	V
		I <sub>O</sub> = -3.1 mA; V <sub>CC</sub> = 2.3 V	1.9	-	-	V
		I <sub>O</sub> = -2.7 mA; V <sub>CC</sub> = 3.0 V	2.72	-	-	V
		I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 3.0 V	2.6	-	-	V
		X2 output; V <sub>I</sub> = GND or V <sub>CC</sub>				
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 0.8 V to 3.6 V	V <sub>CC</sub> - 0.1	-	-	V
		I <sub>O</sub> = -1.1 mA; V <sub>CC</sub> = 1.1 V	0.75 × V <sub>CC</sub>	-	-	V
		I <sub>O</sub> = -1.7 mA; V <sub>CC</sub> = 1.4 V	1.11	-	-	V
		I <sub>O</sub> = -1.9 mA; V <sub>CC</sub> = 1.65 V	1.32	-	-	V
		I <sub>O</sub> = -2.3 mA; V <sub>CC</sub> = 2.3 V	2.05	-	-	V
		I <sub>O</sub> = -3.1 mA; V <sub>CC</sub> = 2.3 V	1.9	-	-	V
		I <sub>O</sub> = -2.7 mA; V <sub>CC</sub> = 3.0 V	2.72	-	-	V
		I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 3.0 V	2.6	-	-	V

**Table 7. Static characteristics ...continued**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
V <sub>OL</sub>	LOW-level output voltage	Y output; V <sub>I</sub> at X1 input = V <sub>IH</sub> or V <sub>IL</sub>					
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 0.8 V to 3.6 V	-	-	0.1	V	
		I <sub>O</sub> = 1.1 mA; V <sub>CC</sub> = 1.1 V	-	-	0.3 × V <sub>CC</sub>	V	
		I <sub>O</sub> = 1.7 mA; V <sub>CC</sub> = 1.4 V	-	-	0.31	V	
		I <sub>O</sub> = 1.9 mA; V <sub>CC</sub> = 1.65 V	-	-	0.31	V	
		I <sub>O</sub> = 2.3 mA; V <sub>CC</sub> = 2.3 V	-	-	0.31	V	
		I <sub>O</sub> = 3.1 mA; V <sub>CC</sub> = 2.3 V	-	-	0.44	V	
		I <sub>O</sub> = 2.7 mA; V <sub>CC</sub> = 3.0 V	-	-	0.31	V	
		I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 3.0 V	-	-	0.44	V	
		X2 output; V <sub>I</sub> = GND or V <sub>CC</sub>					
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 0.8 V to 3.6 V	-	-	0.1	V	
		I <sub>O</sub> = 1.1 mA; V <sub>CC</sub> = 1.1 V	-	-	0.3 × V <sub>CC</sub>	V	
		I <sub>O</sub> = 1.7 mA; V <sub>CC</sub> = 1.4 V	-	-	0.31	V	
		I <sub>O</sub> = 1.9 mA; V <sub>CC</sub> = 1.65 V	-	-	0.31	V	
		I <sub>O</sub> = 2.3 mA; V <sub>CC</sub> = 2.3 V	-	-	0.31	V	
		I <sub>O</sub> = 3.1 mA; V <sub>CC</sub> = 2.3 V	-	-	0.44	V	
		I <sub>O</sub> = 2.7 mA; V <sub>CC</sub> = 3.0 V	-	-	0.31	V	
		I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 3.0 V	-	-	0.44	V	
I <sub>I</sub>	input leakage current	X1 input					
		V <sub>I</sub> = $\overline{\text{EN}}$ = V <sub>CC</sub> ; V <sub>CC</sub> = 0 V to 3.6 V	-	-	±0.1	μA	
		$\overline{\text{EN}}$ input					
		V <sub>I</sub> = GND to 3.6 V; V <sub>CC</sub> = 0 V to 3.6 V	-	-	±0.1	μA	
I <sub>pu</sub>	pull-up current	X1 input; $\overline{\text{EN}}$ = V <sub>CC</sub>					
		V <sub>I</sub> = GND; V <sub>CC</sub> = 0.8 V to 3.6 V	-	-	15	μA	
I <sub>OZ</sub>	OFF-state output current	Y output; V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC</sub> = 0 V to 3.6 V; $\overline{\text{EN}}$ = V <sub>CC</sub>	-	-	±0.1	μA	
I <sub>OFF</sub>	power-off leakage current	V <sub>I</sub> or V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC</sub> = 0 V	<a href="#">1</a>	-	±0.2	μA	
ΔI <sub>OFF</sub>	additional power-off leakage current	V <sub>I</sub> or V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC</sub> = 0 V to 0.2 V	<a href="#">1</a>	-	±0.2	μA	
I <sub>CC</sub>	supply current	V <sub>I</sub> = GND or V <sub>CC</sub> ; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 0.8 V to 3.6 V	-	-	75	μA	
ΔI <sub>CC</sub>	additional supply current	$\overline{\text{EN}}$ input					
		V <sub>I</sub> = V <sub>CC</sub> - 0.6 V; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 3.3 V	-	-	40	μA	
C <sub>I</sub>	input capacitance	X1 input					
		V <sub>CC</sub> = 0 V to 3.6 V; V <sub>I</sub> = GND or V <sub>CC</sub>	-	1.3	-	pF	
		$\overline{\text{EN}}$ input					
		V <sub>CC</sub> = 0 V to 3.6 V; V <sub>I</sub> = GND or V <sub>CC</sub>	-	0.8	-	pF	

**Table 7. Static characteristics ...continued**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
C <sub>O</sub>	output capacitance	X2 output				
		V <sub>O</sub> = GND; V <sub>CC</sub> = 0 V	-	1.5	-	pF
		Y output				
		V <sub>O</sub> = GND; V <sub>CC</sub> = 0 V	-	1.7	-	pF
g <sub>fs</sub>	forward transconductance	see <a href="#">Figure 10</a> and <a href="#">Figure 11</a>				
		V <sub>CC</sub> = 0.8 V	-	-	-	mA/V
		V <sub>CC</sub> = 1.1 V to 1.3 V	0.2	-	9.9	mA/V
		V <sub>CC</sub> = 1.4 V to 1.6 V	3.9	-	17.7	mA/V
		V <sub>CC</sub> = 1.65 V to 1.95 V	7.9	-	24.3	mA/V
		V <sub>CC</sub> = 2.3 V to 2.7 V	18	-	30.7	mA/V
		V <sub>CC</sub> = 3.0 V to 3.6 V	20.5	-	32.4	mA/V
R <sub>bias</sub>	bias resistance	$\overline{\text{EN}}$ = GND; f <sub>i</sub> = 0 Hz; V <sub>I</sub> = 0 V or V <sub>CC</sub> ; See <a href="#">Figure 5</a> ; for frequency behavior see <a href="#">Figure 6</a>	1.08	1.62	3.08	MΩ
<b>T<sub>amb</sub> = -40 °C to +85 °C</b>						
V <sub>IH</sub>	HIGH-level input voltage	X1 input				
		V <sub>CC</sub> = 0.8 V to 3.6 V	0.75 × V <sub>CC</sub>	-	-	V
		$\overline{\text{EN}}$ input				
		V <sub>CC</sub> = 0.8 V	0.70 × V <sub>CC</sub>	-	-	V
		V <sub>CC</sub> = 0.9 V to 1.95 V	0.65 × V <sub>CC</sub>	-	-	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.6	-	-	V
V <sub>IL</sub>	LOW-level input voltage	X1 input				
		V <sub>CC</sub> = 0.8 V to 3.6 V	-	-	0.25 × V <sub>CC</sub>	V
		$\overline{\text{EN}}$ input				
		V <sub>CC</sub> = 0.8 V	-	-	0.30 × V <sub>CC</sub>	V
		V <sub>CC</sub> = 0.9 V to 1.95 V	-	-	0.35 × V <sub>CC</sub>	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	V
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	-	0.9	V

**Table 7. Static characteristics ...continued**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit		
V <sub>OH</sub>	HIGH-level output voltage	Y output; V <sub>I</sub> at X1 input = V <sub>IH</sub> or V <sub>IL</sub>						
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 0.8 V to 3.6 V	V <sub>CC</sub> - 0.1	-	-	V		
		I <sub>O</sub> = -1.1 mA; V <sub>CC</sub> = 1.1 V	0.7 × V <sub>CC</sub>	-	-	V		
		I <sub>O</sub> = -1.7 mA; V <sub>CC</sub> = 1.4 V	1.03	-	-	V		
		I <sub>O</sub> = -1.9 mA; V <sub>CC</sub> = 1.65 V	1.30	-	-	V		
		I <sub>O</sub> = -2.3 mA; V <sub>CC</sub> = 2.3 V	1.97	-	-	V		
		I <sub>O</sub> = -3.1 mA; V <sub>CC</sub> = 2.3 V	1.85	-	-	V		
		I <sub>O</sub> = -2.7 mA; V <sub>CC</sub> = 3.0 V	2.67	-	-	V		
		I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 3.0 V	2.55	-	-	V		
		X2 output; V <sub>I</sub> = GND or V <sub>CC</sub>						
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 0.8 V to 3.6 V	V <sub>CC</sub> - 0.1	-	-	V		
		I <sub>O</sub> = -1.1 mA; V <sub>CC</sub> = 1.1 V	0.7 × V <sub>CC</sub>	-	-	V		
		I <sub>O</sub> = -1.7 mA; V <sub>CC</sub> = 1.4 V	1.03	-	-	V		
		I <sub>O</sub> = -1.9 mA; V <sub>CC</sub> = 1.65 V	1.30	-	-	V		
		I <sub>O</sub> = -2.3 mA; V <sub>CC</sub> = 2.3 V	1.97	-	-	V		
		I <sub>O</sub> = -3.1 mA; V <sub>CC</sub> = 2.3 V	1.85	-	-	V		
		I <sub>O</sub> = -2.7 mA; V <sub>CC</sub> = 3.0 V	2.67	-	-	V		
		I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 3.0 V	2.55	-	-	V		
		V <sub>OL</sub>	LOW-level output voltage	Y output; V <sub>I</sub> at X1 input = V <sub>IH</sub> or V <sub>IL</sub>				
				I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 0.8 V to 3.6 V	-	-	0.1	V
I <sub>O</sub> = 1.1 mA; V <sub>CC</sub> = 1.1 V	-			-	0.3 × V <sub>CC</sub>	V		
I <sub>O</sub> = 1.7 mA; V <sub>CC</sub> = 1.4 V	-			-	0.37	V		
I <sub>O</sub> = 1.9 mA; V <sub>CC</sub> = 1.65 V	-			-	0.35	V		
I <sub>O</sub> = 2.3 mA; V <sub>CC</sub> = 2.3 V	-			-	0.33	V		
I <sub>O</sub> = 3.1 mA; V <sub>CC</sub> = 2.3 V	-			-	0.45	V		
I <sub>O</sub> = 2.7 mA; V <sub>CC</sub> = 3.0 V	-			-	0.33	V		
I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 3.0 V	-			-	0.45	V		
X2 output; V <sub>I</sub> = GND or V <sub>CC</sub>								
I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 0.8 V to 3.6 V	-			-	0.1	V		
I <sub>O</sub> = 1.1 mA; V <sub>CC</sub> = 1.1 V	-			-	0.3 × V <sub>CC</sub>	V		
I <sub>O</sub> = 1.7 mA; V <sub>CC</sub> = 1.4 V	-			-	0.37	V		
I <sub>O</sub> = 1.9 mA; V <sub>CC</sub> = 1.65 V	-			-	0.35	V		
I <sub>O</sub> = 2.3 mA; V <sub>CC</sub> = 2.3 V	-			-	0.33	V		
I <sub>O</sub> = 3.1 mA; V <sub>CC</sub> = 2.3 V	-			-	0.45	V		
I <sub>O</sub> = 2.7 mA; V <sub>CC</sub> = 3.0 V	-			-	0.33	V		
I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 3.0 V	-			-	0.45	V		



**Table 7. Static characteristics ...continued**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$I_I$	input leakage current	X1 input $V_I = \overline{EN} = V_{CC}; V_{CC} = 0 \text{ V to } 3.6 \text{ V}$	-	-	$\pm 0.5$	$\mu\text{A}$
		$\overline{EN}$ input $V_I = \text{GND to } 3.6 \text{ V}; V_{CC} = 0 \text{ V to } 3.6 \text{ V}$	-	-	$\pm 0.5$	$\mu\text{A}$
$I_{pu}$	pull-up current	X1 input; $\overline{EN} = V_{CC}$ $V_I = \text{GND}; V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	15	$\mu\text{A}$
$I_{OZ}$	OFF-state output current	Y output; $V_O = 0 \text{ V to } 3.6 \text{ V}; V_{CC} = 0 \text{ V to } 3.6 \text{ V}; \overline{EN} = V_{CC}$	-	-	$\pm 0.5$	$\mu\text{A}$
$I_{OFF}$	power-off leakage current	$V_I$ or $V_O = 0 \text{ V to } 3.6 \text{ V}; V_{CC} = 0 \text{ V}$	[1]	-	$\pm 0.5$	$\mu\text{A}$
$\Delta I_{OFF}$	additional power-off leakage current	$V_I$ or $V_O = 0 \text{ V to } 3.6 \text{ V}; V_{CC} = 0 \text{ V to } 0.2 \text{ V}$	[1]	-	$\pm 0.6$	$\mu\text{A}$
$I_{CC}$	supply current	$V_I = \text{GND or } V_{CC}; I_O = 0 \text{ A}; V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	75	$\mu\text{A}$
$\Delta I_{CC}$	additional supply current	$\overline{EN}$ input $V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A}; V_{CC} = 3.3 \text{ V}$	-	-	50	$\mu\text{A}$
$g_{fs}$	forward transconductance	see <a href="#">Figure 10</a> and <a href="#">Figure 11</a> $V_{CC} = 0.8 \text{ V}$	-	-	-	$\text{mA/V}$
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$	-	-	10.8	$\text{mA/V}$
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	1.8	-	21.2	$\text{mA/V}$
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	7.5	-	29.9	$\text{mA/V}$
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	15.0	-	38.0	$\text{mA/V}$
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	17.8	-	39.2	$\text{mA/V}$
$R_{bias}$	bias resistance	$\overline{EN} = \text{GND}; f_i = 0 \text{ Hz}; V_I = 0 \text{ V or } V_{CC}$ ; See <a href="#">Figure 5</a> ; for frequency behavior see <a href="#">Figure 6</a>	1.07	-	3.11	$\text{M}\Omega$

**Table 7. Static characteristics ...continued**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>T<sub>amb</sub> = -40 °C to +125 °C</b>						
V <sub>IH</sub>	HIGH-level input voltage	X1 input				
		V <sub>CC</sub> = 0.8 V to 3.6 V	0.75 × V <sub>CC</sub>	-	-	V
		$\overline{\text{EN}}$ input				
		V <sub>CC</sub> = 0.8 V	0.75 × V <sub>CC</sub>	-	-	V
		V <sub>CC</sub> = 0.9 V to 1.95 V	0.70 × V <sub>CC</sub>	-	-	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.6	-	-	V
V <sub>IL</sub>	LOW-level input voltage	X1 input				
		V <sub>CC</sub> = 0.8 V to 3.6 V	-	-	0.25 × V <sub>CC</sub>	V
		$\overline{\text{EN}}$ input				
		V <sub>CC</sub> = 0.8 V	-	-	0.25 × V <sub>CC</sub>	V
		V <sub>CC</sub> = 0.9 V to 1.95 V	-	-	0.30 × V <sub>CC</sub>	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	V
V <sub>OH</sub>	HIGH-level output voltage	Y output; V <sub>I</sub> at X1 input = V <sub>IH</sub> or V <sub>IL</sub>				
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 0.8 V to 3.6 V	V <sub>CC</sub> - 0.11	-	-	V
		I <sub>O</sub> = -1.1 mA; V <sub>CC</sub> = 1.1 V	0.6 × V <sub>CC</sub>	-	-	V
		I <sub>O</sub> = -1.7 mA; V <sub>CC</sub> = 1.4 V	0.93	-	-	V
		I <sub>O</sub> = -1.9 mA; V <sub>CC</sub> = 1.65 V	1.17	-	-	V
		I <sub>O</sub> = -2.3 mA; V <sub>CC</sub> = 2.3 V	1.77	-	-	V
		I <sub>O</sub> = -3.1 mA; V <sub>CC</sub> = 2.3 V	1.67	-	-	V
		I <sub>O</sub> = -2.7 mA; V <sub>CC</sub> = 3.0 V	2.40	-	-	V
		I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 3.0 V	2.30	-	-	V
		X2 output; V <sub>I</sub> = GND or V <sub>CC</sub>				
		I <sub>O</sub> = -20 μA; V <sub>CC</sub> = 0.8 V to 3.6 V	V <sub>CC</sub> - 0.11	-	-	V
		I <sub>O</sub> = -1.1 mA; V <sub>CC</sub> = 1.1 V	0.6 × V <sub>CC</sub>	-	-	V
		I <sub>O</sub> = -1.7 mA; V <sub>CC</sub> = 1.4 V	0.93	-	-	V
		I <sub>O</sub> = -1.9 mA; V <sub>CC</sub> = 1.65 V	1.17	-	-	V
		I <sub>O</sub> = -2.3 mA; V <sub>CC</sub> = 2.3 V	1.77	-	-	V
		I <sub>O</sub> = -3.1 mA; V <sub>CC</sub> = 2.3 V	1.67	-	-	V
		I <sub>O</sub> = -2.7 mA; V <sub>CC</sub> = 3.0 V	2.40	-	-	V
		I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 3.0 V	2.30	-	-	V

**Table 7. Static characteristics ...continued**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

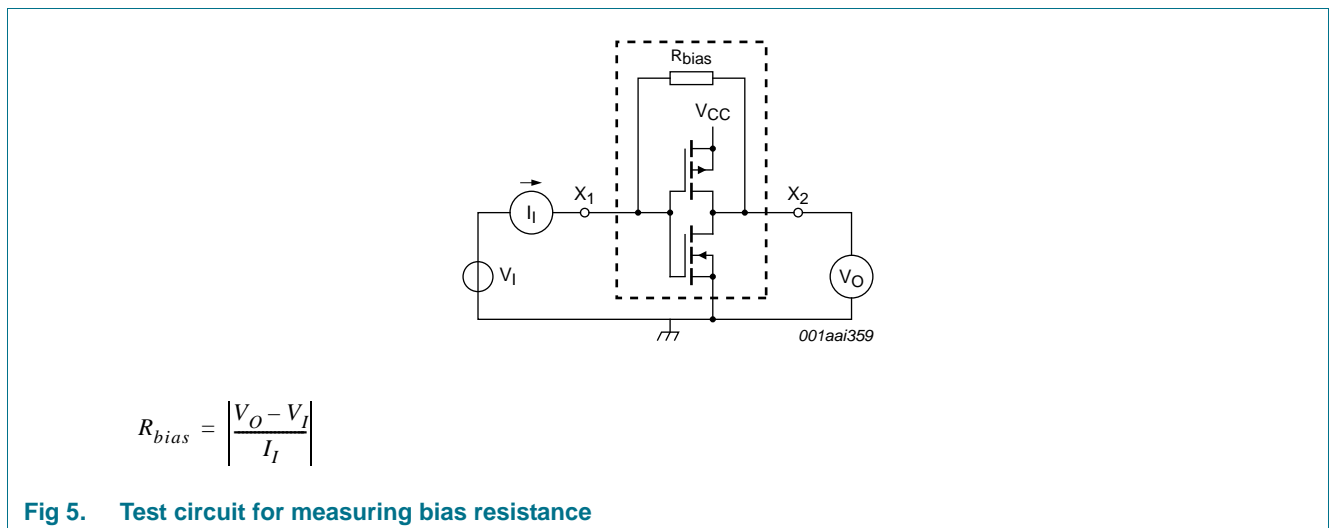
Symbol	Parameter	Conditions	Min	Typ	Max	Unit	
V <sub>OL</sub>	LOW-level output voltage	Y output; V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>					
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 0.8 V to 3.6 V	-	-	0.11	V	
		I <sub>O</sub> = 1.1 mA; V <sub>CC</sub> = 1.1 V	-	-	0.33 × V <sub>CC</sub>	V	
		I <sub>O</sub> = 1.7 mA; V <sub>CC</sub> = 1.4 V	-	-	0.41	V	
		I <sub>O</sub> = 1.9 mA; V <sub>CC</sub> = 1.65 V	-	-	0.39	V	
		I <sub>O</sub> = 2.3 mA; V <sub>CC</sub> = 2.3 V	-	-	0.36	V	
		I <sub>O</sub> = 3.1 mA; V <sub>CC</sub> = 2.3 V	-	-	0.50	V	
		I <sub>O</sub> = 2.7 mA; V <sub>CC</sub> = 3.0 V	-	-	0.36	V	
		I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 3.0 V	-	-	0.50	V	
		X2 output; V <sub>I</sub> = GND or V <sub>CC</sub>					
		I <sub>O</sub> = 20 μA; V <sub>CC</sub> = 0.8 V to 3.6 V	-	-	0.11	V	
		I <sub>O</sub> = 1.1 mA; V <sub>CC</sub> = 1.1 V	-	-	0.33 × V <sub>CC</sub>	V	
		I <sub>O</sub> = 1.7 mA; V <sub>CC</sub> = 1.4 V	-	-	0.41	V	
		I <sub>O</sub> = 1.9 mA; V <sub>CC</sub> = 1.65 V	-	-	0.39	V	
		I <sub>O</sub> = 2.3 mA; V <sub>CC</sub> = 2.3 V	-	-	0.36	V	
		I <sub>O</sub> = 3.1 mA; V <sub>CC</sub> = 2.3 V	-	-	0.50	V	
		I <sub>O</sub> = 2.7 mA; V <sub>CC</sub> = 3.0 V	-	-	0.36	V	
		I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 3.0 V	-	-	0.50	V	
I <sub>I</sub>	input leakage current	X1 input					
		V <sub>I</sub> = $\overline{\text{EN}}$ = V <sub>CC</sub> ; V <sub>CC</sub> = 0 V to 3.6 V	-	-	±0.75	μA	
		$\overline{\text{EN}}$ input					
		V <sub>I</sub> = GND to 3.6 V; V <sub>CC</sub> = 0 V to 3.6 V	-	-	±0.75	μA	
I <sub>pu</sub>	pull-up current	X1 input; $\overline{\text{EN}}$ = V <sub>CC</sub>					
		V <sub>I</sub> = GND; V <sub>CC</sub> = 0.8 V to 3.6 V	-	-	15	μA	
I <sub>OZ</sub>	OFF-state output current	Y output; V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC</sub> = 0 V to 3.6 V; $\overline{\text{EN}}$ = V <sub>CC</sub>	-	-	±0.75	μA	
I <sub>OFF</sub>	power-off leakage current	V <sub>I</sub> or V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC</sub> = 0 V	<a href="#">1</a>	-	±0.75	μA	
ΔI <sub>OFF</sub>	additional power-off leakage current	V <sub>I</sub> or V <sub>O</sub> = 0 V to 3.6 V; V <sub>CC</sub> = 0 V to 0.2 V	<a href="#">1</a>	-	±0.75	μA	
I <sub>CC</sub>	supply current	V <sub>I</sub> = GND or V <sub>CC</sub> ; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 0.8 V to 3.6 V	-	-	75	μA	
ΔI <sub>CC</sub>	additional supply current	$\overline{\text{EN}}$ input					
		V <sub>I</sub> = V <sub>CC</sub> - 0.6 V; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 3.3 V	-	-	75	μA	

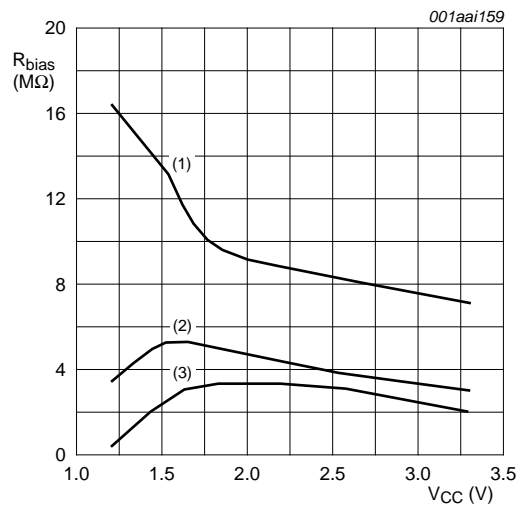
**Table 7. Static characteristics ...continued**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
g <sub>fs</sub>	forward transconductance	see <a href="#">Figure 10</a> and <a href="#">Figure 11</a>				
		V <sub>CC</sub> = 0.8 V	-	-	-	mA/V
		V <sub>CC</sub> = 1.1 V to 1.3 V	-	-	10.8	mA/V
		V <sub>CC</sub> = 1.4 V to 1.6 V	1.8	-	21.2	mA/V
		V <sub>CC</sub> = 1.65 V to 1.95 V	6.9	-	29.9	mA/V
		V <sub>CC</sub> = 2.3 V to 2.7 V	13.4	-	38.0	mA/V
		V <sub>CC</sub> = 3.0 V to 3.6 V	15.8	-	39.2	mA/V
R <sub>bias</sub>	bias resistance	$\overline{EN} = \text{GND}$ ; f <sub>i</sub> = 0 Hz; V <sub>I</sub> = 0 V or V <sub>CC</sub> ; See <a href="#">Figure 5</a> ; for frequency behavior see <a href="#">Figure 6</a>	1.07	-	3.11	MΩ

[1] Only for output Y and input  $\overline{EN}$ .





- (1)  $f_i = 30 \text{ kHz}$ .
- (2)  $f_i = 1 \text{ MHz}$ .
- (3)  $f_i = 10 \text{ MHz}$ .

Fig 6. Typical bias resistance versus supply voltage

## 11. Dynamic characteristics

**Table 8. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V); for test circuit see [Figure 9](#).

Symbol	Parameter	Conditions	25 °C			-40 °C to +125 °C			Unit
			Min	Typ <sup>[1]</sup>	Max	Min	Max (85 °C)	Max (125 °C)	
<b>C<sub>L</sub> = 5 pF</b>									
t <sub>pd</sub>	propagation delay	X1 to X2; see <a href="#">Figure 7</a>	<a href="#">[2]</a>						
		V <sub>CC</sub> = 0.8 V	-	6.2	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	0.9	2.3	4.4	0.9	4.8	5.3	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	0.7	1.7	3.1	0.6	3.4	3.8	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	0.5	1.4	2.6	0.5	2.9	3.2	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	0.4	1.1	2.0	0.4	2.3	2.6	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	0.3	1.0	1.8	0.3	2.1	2.4	ns
		X1 to Y; see <a href="#">Figure 7</a>	<a href="#">[2]</a>						
		V <sub>CC</sub> = 0.8 V	-	18.5	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	2.8	5.9	12.5	3.2	14.8	16.3	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.2	4.2	7.7	2.6	9.1	10.1	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.9	3.5	6.2	2.2	7.8	8.6	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.6	2.9	4.8	1.9	6.2	6.9	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.4	2.6	4.1	1.7	4.7	5.2	ns
t <sub>en</sub>	enable time	$\overline{\text{EN}}$ to Y; see <a href="#">Figure 8</a>	<a href="#">[3]</a>						
		V <sub>CC</sub> = 0.8 V	-	31.2	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	3.1	6.1	13.8	2.9	16.3	18.0	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.5	4.3	8.2	2.3	9.7	10.7	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.1	3.6	6.5	2.0	7.6	8.4	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.8	2.9	4.8	1.7	5.8	6.4	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.7	2.6	4.1	1.7	4.7	5.2	ns
t <sub>dis</sub>	disable time	$\overline{\text{EN}}$ to Y; see <a href="#">Figure 8</a>	<a href="#">[4]</a>						
		V <sub>CC</sub> = 0.8 V	-	11.1	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	2.5	4.5	9.0	2.9	9.4	10.4	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.0	3.3	6.4	2.3	6.7	7.4	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.9	3.2	6.0	2.0	6.4	7.1	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.4	2.3	4.4	1.7	4.7	5.2	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.7	2.6	4.4	1.7	4.9	5.4	ns

**Table 8. Dynamic characteristics ...continued**Voltages are referenced to GND (ground = 0 V); for test circuit see [Figure 9](#).

Symbol	Parameter	Conditions	25 °C			–40 °C to +125 °C			Unit
			Min	Typ <sup>[1]</sup>	Max	Min	Max (85 °C)	Max (125 °C)	
<b>C<sub>L</sub> = 10 pF</b>									
t <sub>pd</sub>	propagation delay	X1 to X2; see <a href="#">Figure 7</a>	<a href="#">[2]</a>						
		V <sub>CC</sub> = 0.8 V	-	9.6	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	1.2	3.1	6.1	1.2	6.8	7.5	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	1.0	2.3	4.0	0.9	4.6	5.1	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	0.8	1.9	3.3	0.7	3.8	4.2	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	0.6	1.5	2.7	0.6	3.1	3.5	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	0.5	1.3	2.4	0.5	2.7	3.0	ns
		X1 to Y; see <a href="#">Figure 7</a>	<a href="#">[2]</a>						
		V <sub>CC</sub> = 0.8 V	-	21.4	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	3.2	6.7	14.3	3.6	16.2	17.9	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.1	4.9	8.9	3.0	10.1	11.2	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.9	4.1	6.9	2.6	8.0	8.8	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	2.1	3.4	5.4	2.3	6.6	7.3	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.8	3.1	4.8	2.1	5.6	6.2	ns
t <sub>en</sub>	enable time	$\overline{\text{EN}}$ to Y; see <a href="#">Figure 8</a>	<a href="#">[3]</a>						
		V <sub>CC</sub> = 0.8 V	-	34.4	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	3.6	6.9	15.5	3.4	16.0	17.6	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.3	5.0	9.3	2.2	9.6	10.6	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.0	4.2	7.2	1.9	7.9	8.7	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.8	3.4	5.5	1.7	6.4	7.1	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.7	3.2	4.9	1.7	5.5	6.1	ns
t <sub>dis</sub>	disable time	$\overline{\text{EN}}$ to Y; see <a href="#">Figure 8</a>	<a href="#">[4]</a>						
		V <sub>CC</sub> = 0.8 V	-	13.0	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	3.4	5.7	10.4	3.4	10.8	11.9	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.1	4.2	7.6	2.2	8.0	8.8	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.2	4.3	7.3	1.9	7.6	8.4	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.6	3.1	5.3	1.7	5.5	6.1	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	2.1	3.8	6.0	1.7	6.5	7.2	ns

**Table 8. Dynamic characteristics ...continued**  
 Voltages are referenced to GND (ground = 0 V); for test circuit see [Figure 9](#).

Symbol	Parameter	Conditions	25 °C			−40 °C to +125 °C			Unit
			Min	Typ <sup>[1]</sup>	Max	Min	Max (85 °C)	Max (125 °C)	
<b>C<sub>L</sub> = 15 pF</b>									
t <sub>pd</sub>	propagation delay	X1 to X2; see <a href="#">Figure 7</a> <sup>[2]</sup>							
		V <sub>CC</sub> = 0.8 V	-	13.0	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	1.6	3.8	7.9	1.4	8.8	9.7	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	1.3	2.8	4.9	1.1	5.7	6.3	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.0	2.3	4.0	0.9	4.7	5.2	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	0.8	1.9	3.2	0.8	3.7	4.1	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	0.7	1.6	2.9	0.7	3.3	3.7	ns
		X1 to Y; see <a href="#">Figure 7</a> <sup>[2]</sup>							
		V <sub>CC</sub> = 0.8 V	-	24.2	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	3.6	7.5	16.1	4.0	17.6	19.4	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	3.0	5.4	9.7	3.3	10.6	11.7	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.2	4.6	7.7	2.9	9.0	9.9	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	2.0	3.9	6.1	2.6	7.3	8.1	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	2.0	3.6	5.4	2.3	5.9	6.5	ns
t <sub>en</sub>	enable time	$\overline{\text{EN}}$ to Y; see <a href="#">Figure 8</a> <sup>[3]</sup>							
		V <sub>CC</sub> = 0.8 V	-	37.5	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	4.0	7.7	17.2	3.7	17.5	19.3	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	3.0	5.5	10.0	2.5	10.2	11.3	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.3	4.7	7.9	2.1	9.2	10.2	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	2.0	3.9	6.2	2.0	7.4	8.2	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	2.0	3.6	5.5	1.9	6.0	6.6	ns
t <sub>dis</sub>	disable time	$\overline{\text{EN}}$ to Y; see <a href="#">Figure 8</a> <sup>[4]</sup>							
		V <sub>CC</sub> = 0.8 V	-	14.8	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	4.3	6.8	11.2	3.7	12.4	13.7	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	3.0	5.1	8.1	2.5	8.9	9.8	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	3.0	5.4	8.0	2.1	9.3	10.3	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	2.1	3.9	6.1	2.0	7.3	8.1	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	2.9	5.1	7.2	1.9	7.9	8.7	ns



**Table 8. Dynamic characteristics ...continued**  
 Voltages are referenced to GND (ground = 0 V); for test circuit see [Figure 9](#).

Symbol	Parameter	Conditions	25 °C			-40 °C to +125 °C			Unit
			Min	Typ <sup>[1]</sup>	Max	Min	Max (85 °C)	Max (125 °C)	
<b>C<sub>L</sub> = 30 pF</b>									
t <sub>pd</sub>	propagation delay	X1 to X2; see <a href="#">Figure 7</a> <sup>[2]</sup>							
		V <sub>CC</sub> = 0.8 V	-	23.2	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	2.4	6.0	13.1	2.2	14.8	16.3	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	2.0	4.2	7.6	1.8	9.0	9.9	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	1.7	3.6	6.1	1.5	7.2	8.0	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.4	2.9	4.8	1.3	5.7	6.3	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	1.2	2.5	4.3	1.1	5.1	5.7	ns
		X1 to Y; see <a href="#">Figure 7</a> <sup>[2]</sup>							
		V <sub>CC</sub> = 0.8 V	-	32.6	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	4.8	9.6	21.0	5.0	21.7	23.9	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	4.0	6.9	12.4	4.3	13.5	14.9	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	2.9	5.9	9.8	3.8	10.7	11.8	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	2.7	5.0	7.5	3.3	8.2	9.1	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	2.7	4.7	6.8	3.1	7.7	8.5	ns
t <sub>en</sub>	enable time	$\overline{\text{EN}}$ to Y; see <a href="#">Figure 8</a> <sup>[3]</sup>							
		V <sub>CC</sub> = 0.8 V	-	47.1	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	5.2	9.9	21.0	4.8	21.7	23.9	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	4.0	7.1	12.4	3.1	13.5	14.9	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	3.0	6.0	9.9	2.8	10.7	11.8	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	2.7	5.0	7.7	2.6	8.1	9.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	2.7	4.8	6.8	2.6	7.7	8.5	ns
t <sub>dis</sub>	disable time	$\overline{\text{EN}}$ to Y; see <a href="#">Figure 8</a> <sup>[4]</sup>							
		V <sub>CC</sub> = 0.8 V	-	20.3	-	-	-	-	ns
		V <sub>CC</sub> = 1.1 V to 1.3 V	6.0	10.2	15.3	4.8	16.5	18.2	ns
		V <sub>CC</sub> = 1.4 V to 1.6 V	4.4	7.8	11.2	3.1	12.3	13.6	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V	5.1	8.8	12.5	2.8	13.3	14.7	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V	3.6	6.3	8.6	2.6	9.5	10.5	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V	5.2	8.8	11.5	2.6	13.0	14.3	ns

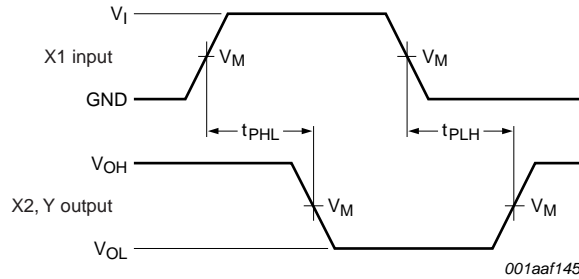
**Table 8. Dynamic characteristics ...continued**

Voltages are referenced to GND (ground = 0 V); for test circuit see [Figure 9](#).

Symbol	Parameter	Conditions	25 °C			–40 °C to +125 °C			Unit
			Min	Typ <sup>[1]</sup>	Max	Min	Max (85 °C)	Max (125 °C)	
<b>C<sub>L</sub> = 5 pF, 10 pF, 15 pF and 30 pF</b>									
C <sub>PD</sub>	power dissipation capacitance	f <sub>i</sub> = 1 MHz; $\overline{EN}$ = GND; V <sub>I</sub> = GND to V <sub>CC</sub> <span style="float:right">[5][6]</span>							
		V <sub>CC</sub> = 0.8 V	-	7.1	-	-	-	-	pF
		V <sub>CC</sub> = 1.1 V to 1.3 V	-	12.9	-	-	-	-	pF
		V <sub>CC</sub> = 1.4 V to 1.6 V	-	19.2	-	-	-	-	pF
		V <sub>CC</sub> = 1.65 V to 1.95 V	-	19.9	-	-	-	-	pF
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	21.6	-	-	-	-	pF
		V <sub>CC</sub> = 3.0 V to 3.6 V	-	24.3	-	-	-	-	pF

- [1] All typical values are measured at nominal V<sub>CC</sub>.
- [2] t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>.
- [3] t<sub>en</sub> is the same as t<sub>PZH</sub> and t<sub>PZL</sub>.
- [4] t<sub>dis</sub> is the same as t<sub>PHZ</sub> and t<sub>PLZ</sub>.
- [5] C<sub>PD</sub> is used to determine the dynamic power dissipation (P<sub>D</sub> in μW).  
 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$  where:  
 f<sub>i</sub> = input frequency in MHz;  
 f<sub>o</sub> = output frequency in MHz;  
 C<sub>L</sub> = output load capacitance in pF;  
 V<sub>CC</sub> = supply voltage in V;  
 N = number of inputs switching;  
 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.
- [6] Feedback current is included in C<sub>PD</sub>.

12. Waveforms

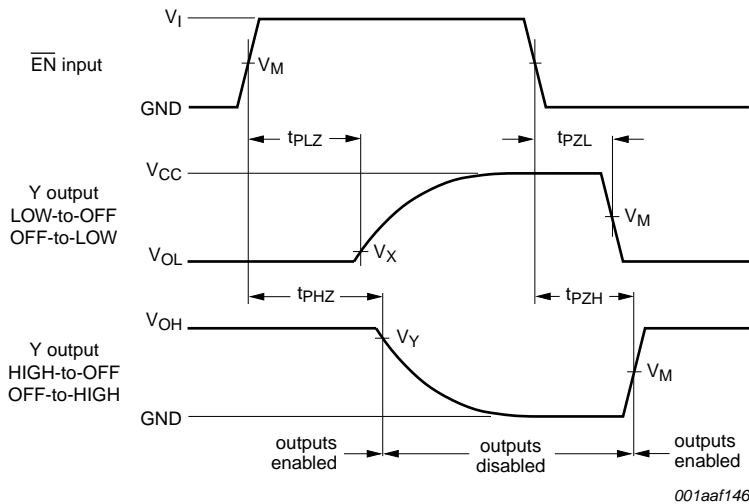


Measurement points are given in [Table 9](#).  
 Logic levels:  $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

**Fig 7. The input (X1) to output (X2, Y) propagation delays**

**Table 9. Measurement points**

Supply voltage	Output	Input		
$V_{CC}$	$V_M$	$V_M$	$V_I$	$t_r = t_f$
0.8 V to 3.6 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{CC}$	$\leq 3.0$ ns

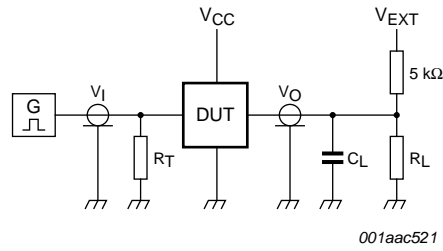


Measurement points are given in [Table 10](#).  
 Logic levels:  $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

**Fig 8. Enable and disable times**

**Table 10. Measurement points**

Supply voltage	Input	Output		
$V_{CC}$	$V_M$	$V_M$	$V_X$	$V_Y$
0.8 V to 1.6 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.1$ V	$V_{OH} - 0.1$ V
1.65 V to 2.7 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.15$ V	$V_{OH} - 0.15$ V
3.0 V to 3.6 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.3$ V	$V_{OH} - 0.3$ V



Test data is given in [Table 11](#).

Definitions for test circuit:

$R_L$  = Load resistance.

$C_L$  = Load capacitance including jig and probe capacitance.

$R_T$  = Termination resistance should be equal to the output impedance  $Z_o$  of the pulse generator.

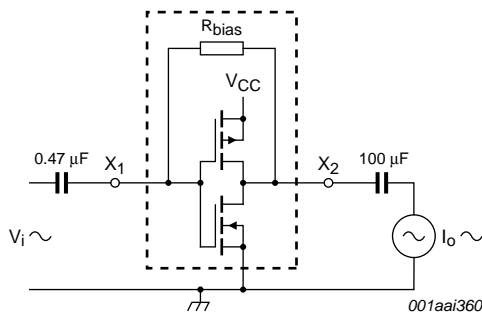
$V_{EXT}$  = External voltage for measuring switching times.

**Fig 9. Test circuit for measuring switching times**

**Table 11. Test data**

Supply voltage	Load		$V_{EXT}$		
$V_{CC}$	$C_L$	$R_L$ [1]	$t_{PLH}$ , $t_{PHL}$	$t_{PZH}$ , $t_{PHZ}$	$t_{PZL}$ , $t_{PLZ}$
0.8 V to 3.6 V	5 pF, 10 pF, 15 pF and 30 pF	5 kΩ or 1 MΩ	open	GND	$2 \times V_{CC}$

[1] For measuring enable and disable times  $R_L = 5 \text{ k}\Omega$ , for measuring propagation delays, setup and hold times and pulse width  $R_L = 1 \text{ M}\Omega$ .

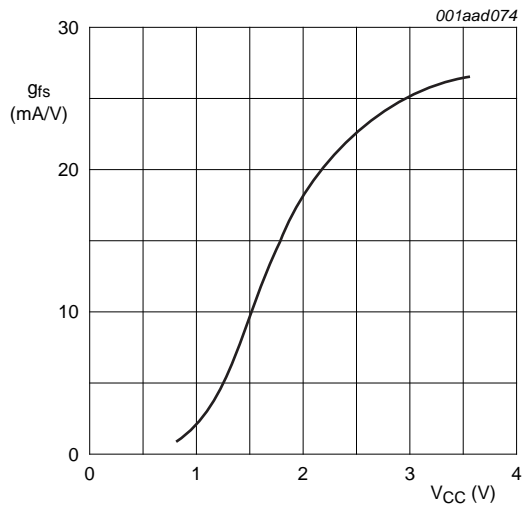


$$g_{fs} = \frac{\Delta I_O}{\Delta V_I}$$

$f_i = 1 \text{ kHz}$ .

$V_O$  is constant.

**Fig 10. Test set-up for measuring forward transconductance**



$T_{amb} = 25 \text{ }^\circ\text{C}$ .

**Fig 11. Typical forward transconductance as a function of supply voltage**

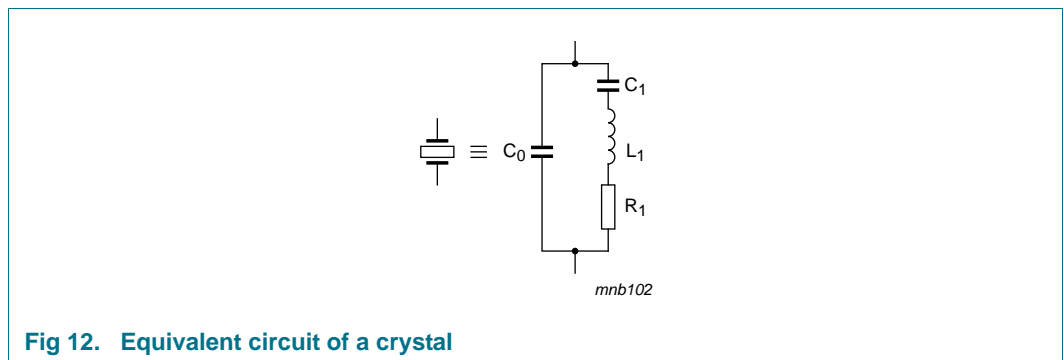
## 13. Application information

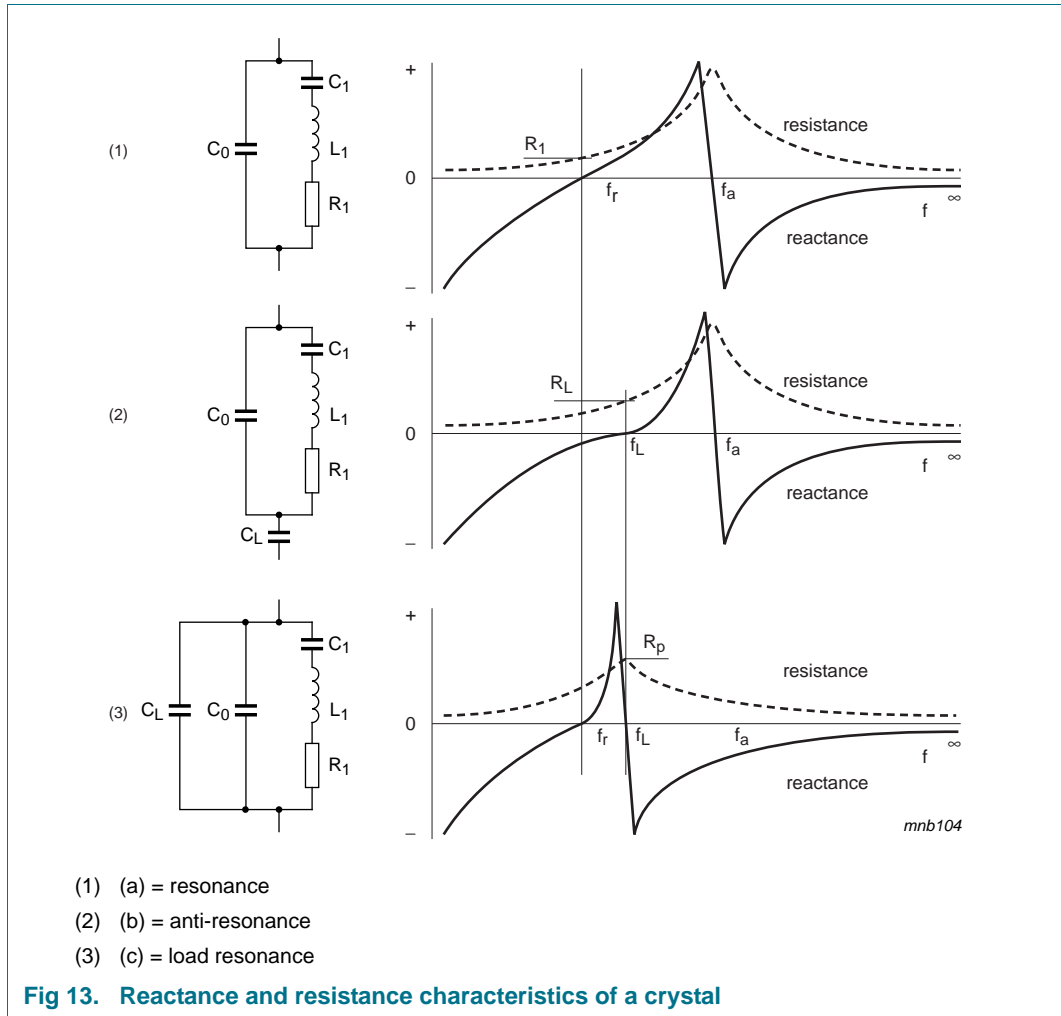
Crystal controlled oscillator circuits are widely used in clock pulse generators because of their excellent frequency stability and wide operating frequency range. The use of the 74AUP1Z125 provides the additional advantages of low power dissipation, stable operation over a wide range of frequency and temperature and a very small footprint. This application information describes crystal characteristics, design and testing of crystal oscillator circuits based on the 74AUP1Z125.

### 13.1 Crystal characteristics

[Figure 12](#) is the equivalent circuit of a quartz crystal.

The reactive and resistive components of the impedance of the crystal alone, and the crystal with a series and a parallel capacitance, is shown in [Figure 13](#).





13.1.1 Design

Figure 14 shows the recommended way to connect a crystal to the 74AUP1Z125. This circuit is basically a Pierce oscillator circuit in which the crystal is operating at its fundamental frequency and tuned by the parallel load capacitance of C<sub>1</sub> and C<sub>2</sub>. C<sub>1</sub> and C<sub>2</sub> are in series with the crystal. They should be approximately equal. R<sub>1</sub> is the drive-limiting resistor and is set to approximately the same value as the reactance of C<sub>1</sub> at the crystal frequency (R<sub>1</sub> = X<sub>C1</sub>). This results in an input to the crystal of 50 % of the rail-to-rail output of X2. This keeps the drive level into the crystal within drive specifications (the designer should verify this). Overdriving the crystal can cause damage.

The internal bias resistor provides negative feedback and sets a bias point of the inverter near mid-supply, operating the 74AUP1GU04 in the high gain linear region.

To calculate the values of C<sub>1</sub> and C<sub>2</sub>, the designer can use the formula:

$$C_L = \frac{C_1 \times C_2}{C_1 + C_2} + C_s$$

C<sub>L</sub> is the load capacitance as specified by the crystal manufacturer. C<sub>s</sub> is the stray capacitance of the circuit and for 74AUP1Z125, C<sub>s</sub> is equal to an input capacitance of 1.5 pF.

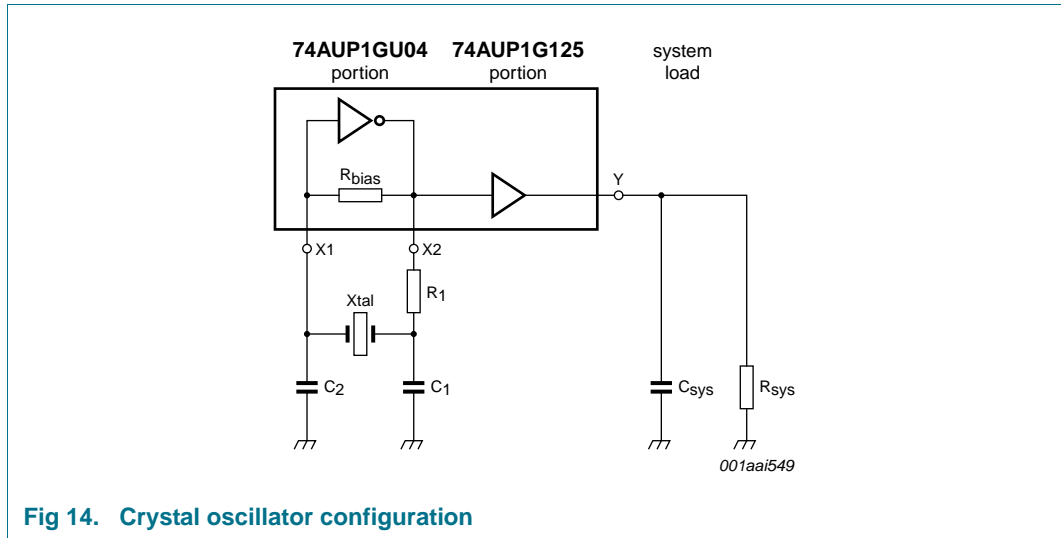


Fig 14. Crystal oscillator configuration

### 13.1.2 Testing

After the calculations are performed for a particular crystal, the oscillator circuit should be tested. The following simple checks verify the prototype design of a crystal controlled oscillator circuit. Perform the checks after laying out the board:

- Test the oscillator over worst-case conditions (lowest supply voltage, worst-case crystal and highest operating temperature). Adding series and parallel resistors can simulate a worse case crystal.
- Insure that the circuit does not oscillate without the crystal.
- Check the frequency stability over a supply range greater than that which is likely to occur during normal operation.
- Check that the start-up time is within system requirements.

As the 74AUP1Z125 isolates the system loading, once the design is optimized, the single layout may work in multiple applications for any given crystal.

14. Package outline

Plastic surface-mounted package; 6 leads

SOT363

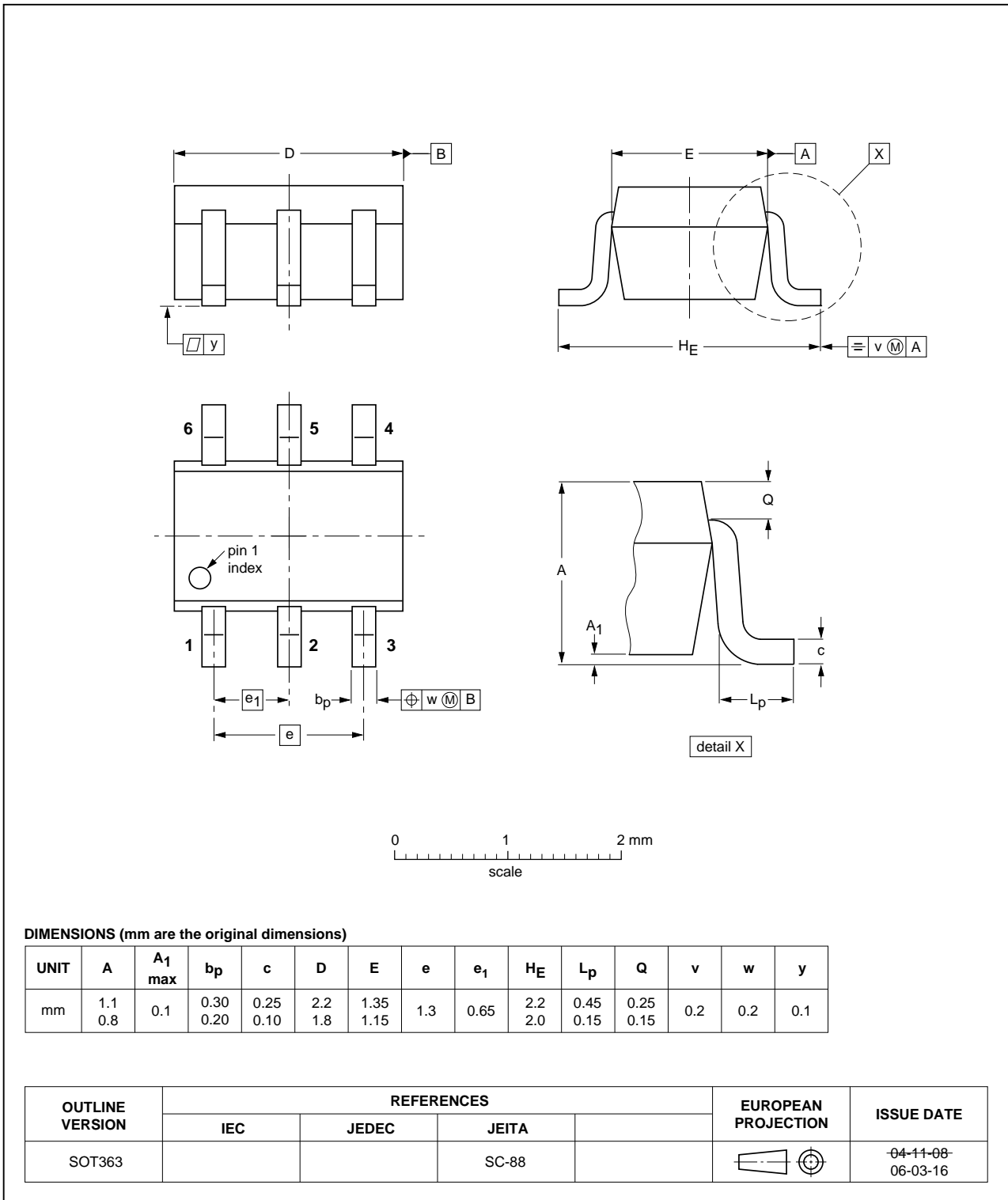


Fig 15. Package outline SOT363 (SC-88)



XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1.45 x 0.5 mm

SOT886

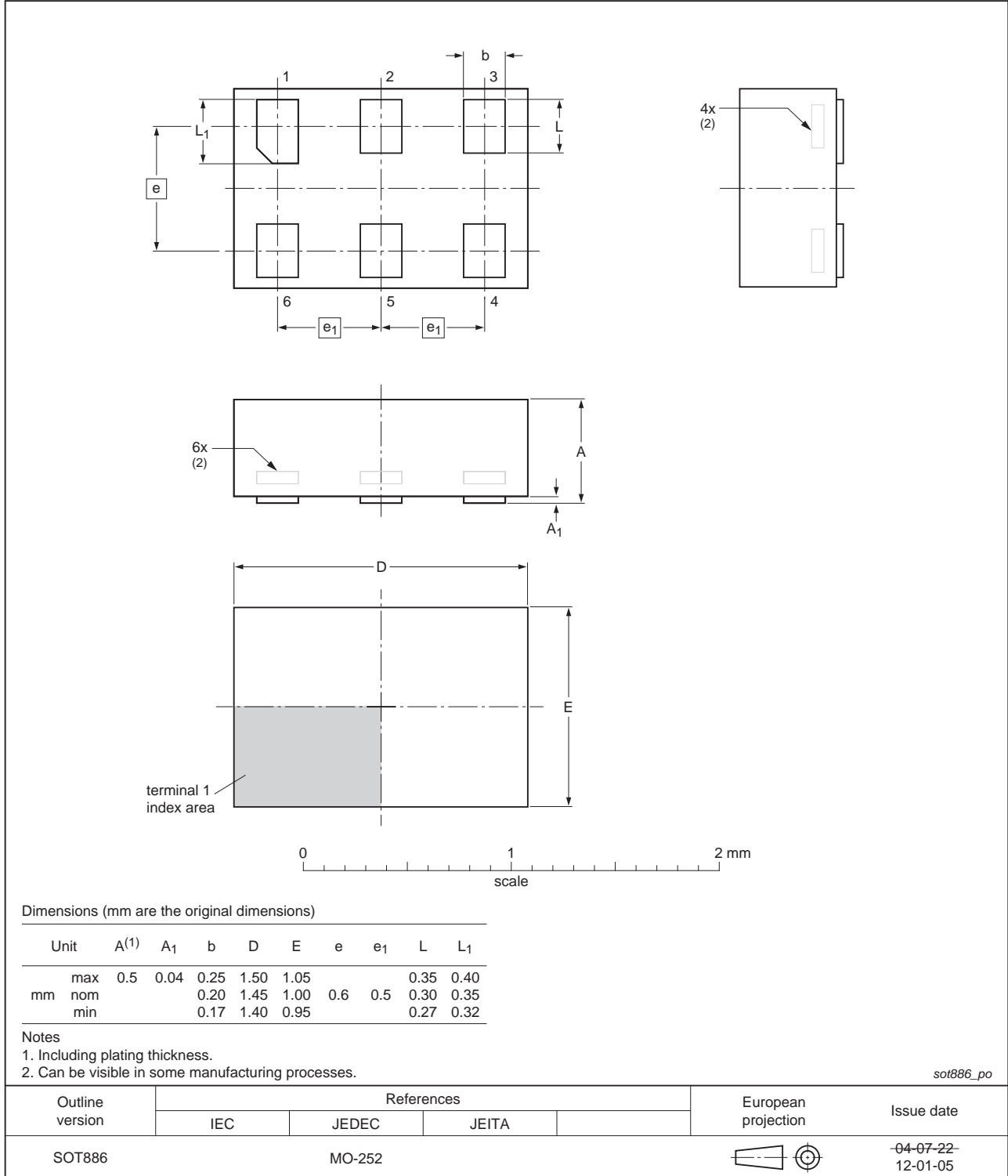


Fig 16. Package outline SOT886 (XSON6)

XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1 x 0.5 mm

SOT891

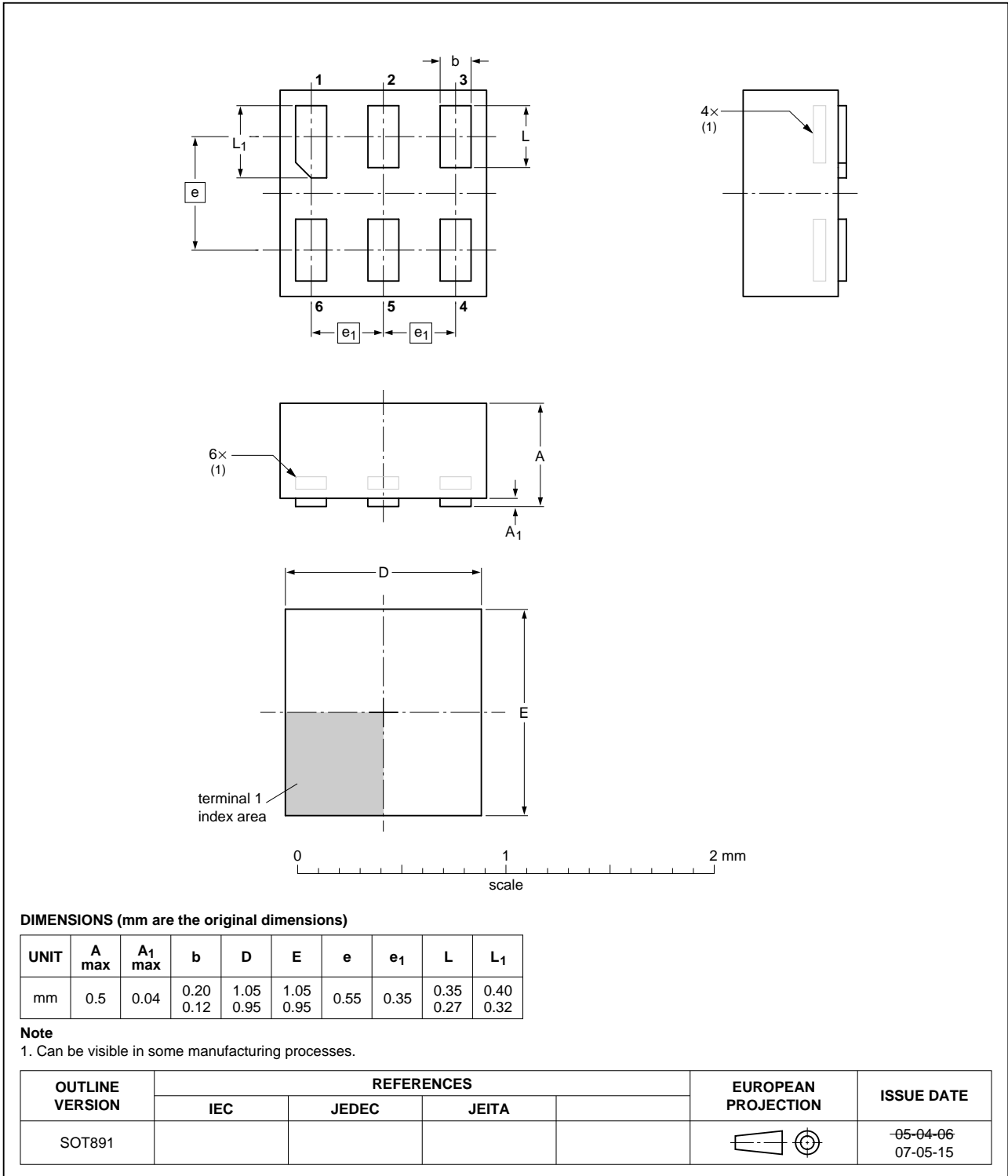


Fig 17. Package outline SOT891 (XSON6)

**XSON6: extremely thin small outline package; no leads;  
6 terminals; body 0.9 x 1.0 x 0.35 mm**

SOT1115

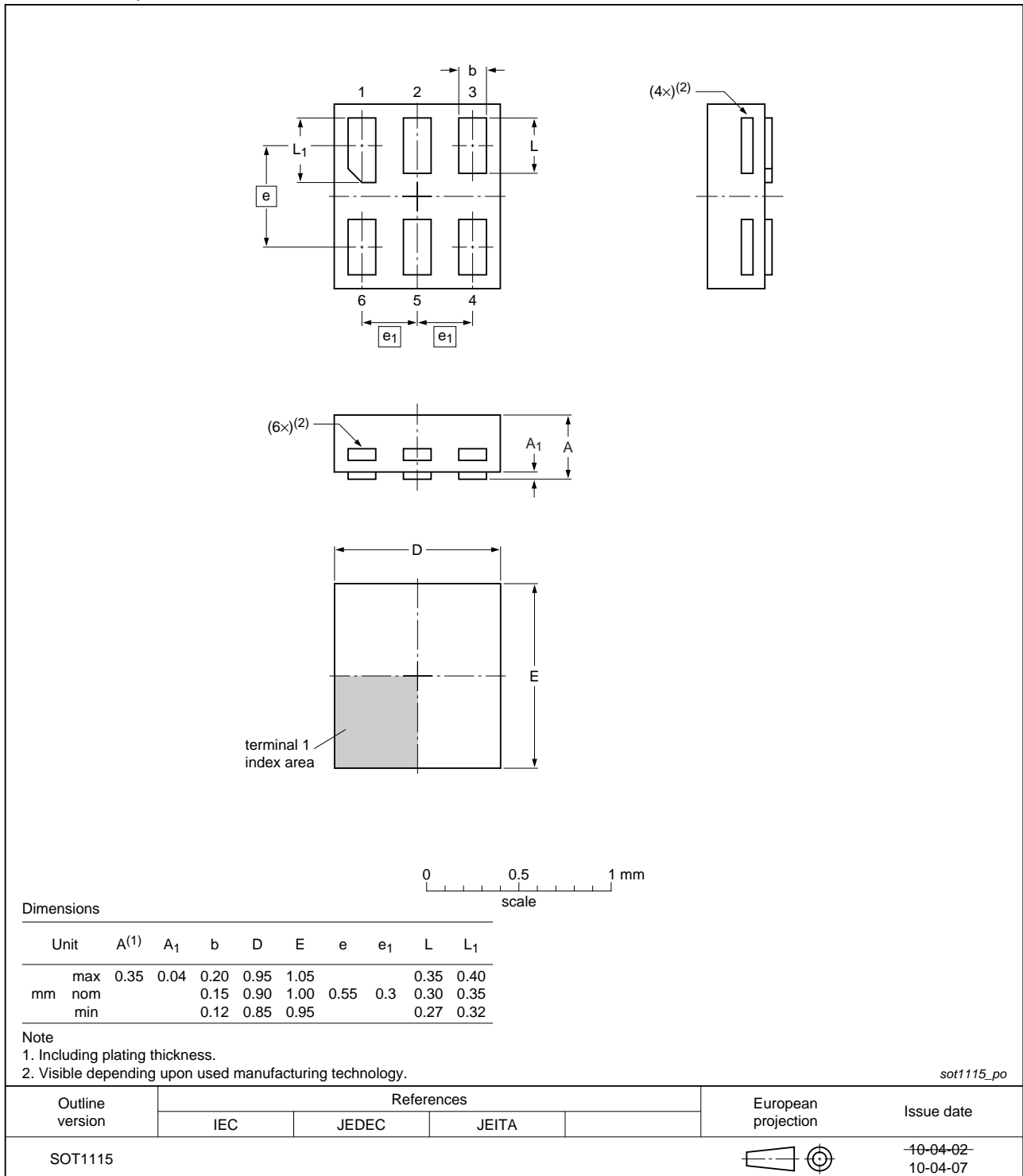
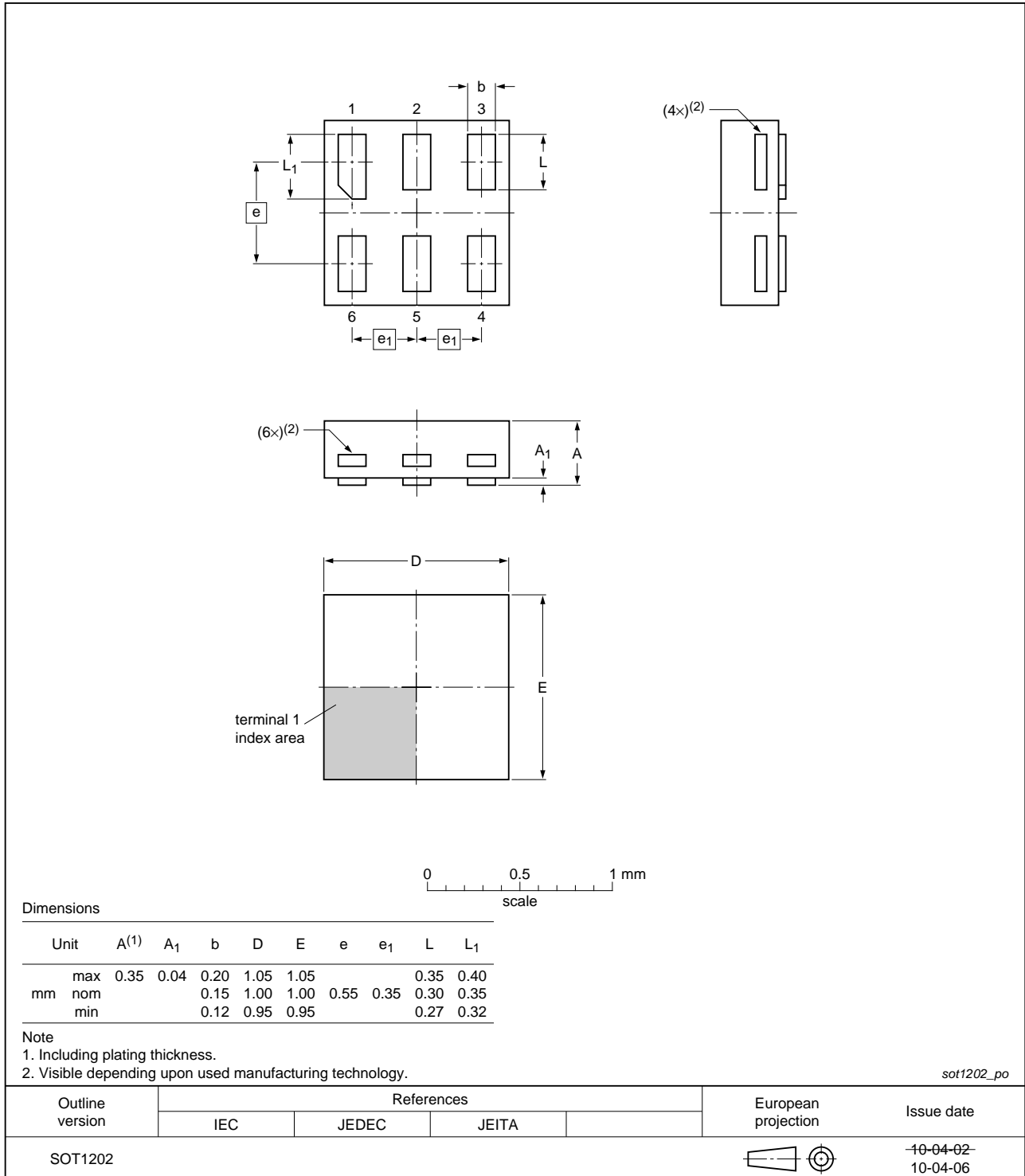


Fig 18. Package outline SOT1115 (XSON6)

**XSON6: extremely thin small outline package; no leads;  
6 terminals; body 1.0 x 1.0 x 0.35 mm**

**SOT1202**



**Fig 19. Package outline SOT1202 (XSON6)**

## 15. Abbreviations

Table 12. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model

## 16. Revision history

Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AUP1Z125 v.5	20120808	Product data sheet	-	74AUP1Z125 v.4
Modifications:	<ul style="list-style-type: none"> <li>Package outline drawing of SOT886 (<a href="#">Figure 16</a>) modified.</li> </ul>			
74AUP1Z125 v.4	20111201	Product data sheet	-	74AUP1Z125 v.3
Modifications:	<ul style="list-style-type: none"> <li>Legal pages updated.</li> </ul>			
74AUP1Z125 v.3	20100909	Product data sheet	-	74AUP1Z125 v.2
74AUP1Z125 v.2	20080807	Product data sheet	-	74AUP1Z125 v.1
74AUP1Z125 v.1	20060803	Product data sheet	-	-

## 17. Legal information

### 17.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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